

Rated Current:2.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:-40°c to +105°c

Rated Current:2.0AMP

Contact Resistance:20mΩ Max

Withstand Voltage:500V AC/DC

Insulation Resistance:1000MΩ Min

Operation Temperature: -40°C to +105°C

Contact Material:Brass

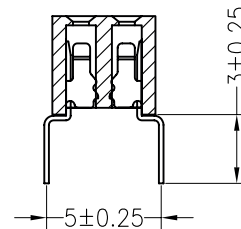
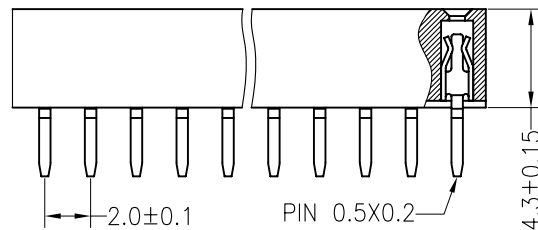
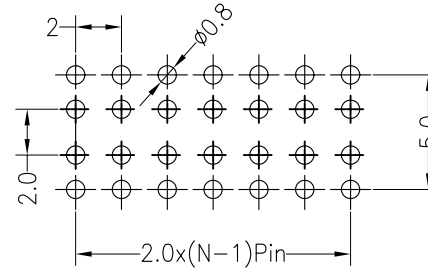
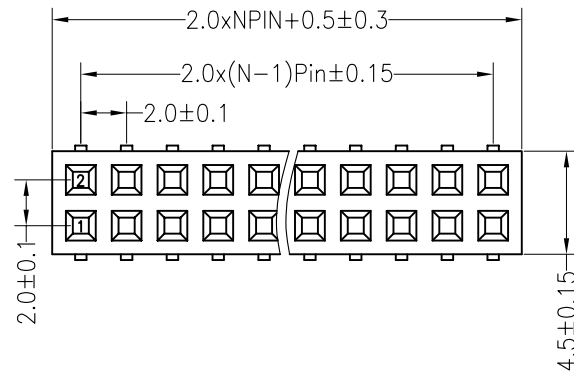
Contact Plating: Au Over Ni

Insulator Material:Polyester(UL94V-0)

Standard: PA6T

Max.Processing Temp: 230°C for 30–60 seconds
(260°C for 10 seconds)

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE ± 0.05)



FAMILY	PITCH	N° ROWS	N° PIN P.R.	VERSION	CLIP PLATING	HEIGHT	OPTION	PACKAGE
FH	200	2	XX	D [straight]	F [flash gold]	043	04 [pitch 5,00]	T [tube]
					G [15u gold]			V [tray/bag]



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UL[®]
C US
FILE N. E356435

UNITS: mm

SHEET SIZE: ISO A4

SCALE:

$> 0 \sim 3$

$$> 3 \sim 18$$

> 18 ~ 50

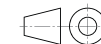
> 50 ~ 120

 ± 0.12

± 0.15

± 0.3

± 0.5



- First angle projection

HEADER